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DIALOG(R) File 351: Derwent WPI
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014866404
WPI Acc No: 2002-687110/200274
XRAM Acc No: C02-194280
 Thermoplastic elastomer composition, used as molding material for
preparation of e.g. automotive and domestic appliance parts, comprises
polyisobutyrene block-polystyrene block copolymer and polyphenylene
ether
 resin
Patent Assignee: KANEKA CORP (KANF )
Number of Countries: 001 Number of Patents: 001
Patent Family:
                                            Kind
                                                   Date
                                                             Week
Patent No
              Kind
                     Date
                             Applicat No
JP 2002226665 A
                   20020814
                             JP 200122333
                                             Α
                                                 20010130
                                                           200274 B
Priority Applications (No Type Date): JP 200122333 A 20010130
Patent Details:
                         Main IPC
Patent No Kind Lan Pg
                                     Filing Notes
JP 2002226665 A
                     8 C08L-053/00
Abstract (Basic): JP 2002226665 A
        NOVELTY - A thermoplastic elastomer composition (I) comprises:
(A)
    a block copolymer composed of (A1) isobutyrene polymer block and
(A2)
    an aromatic vinyl polymer block (99-50 wt.%); and (B) polyphenylene
    ether resin (1-50 wt.%).
        USE - The thermoplastic elastomer composition (I) is useful as
    molding material for preparation of automotive parts, domestic
    appliance parts, packings, gaskets, medical instruments etc, and is
    also useful as wire insulating compound, sealing compound, etc.
        ADVANTAGE - The thermoplastic elastomer composition (I) has
    improved permanent set.
        pp; 8 DwgNo 0/0
Technology Focus:
        TECHNOLOGY FOCUS - POLYMERS - Preferred Copolymer: The block
    copolymer (A) is composed of (A1) (50-95 wt.%, more preferably 70-
95
    wt%) and (A2) (50-5 wt.%, more preferably 30-5 wt.%). Preferred
(A2) is
    (co)polymer of styrene and/or alpha-methylstyrene).
        Preferred Properties: The Mw of (A) is 3,000-1,000,000
(preferably
    5,000-500,000, and optimally 20,000-100,000).
        Preferred Resin: The polyphenylene ether resin (B) is
preferably
    composed of polyphenylene ether resin (especially
    poly(2,6-dimethyl-1,4-phenylene) ether resin) (50-100 wt.%) and
    polystyrene resin (50-0 wt.%).
        Preferred Composition: The elastomer composition (I) is
prepared by
    blending (A), (B) and optional additive(s) (e.g. plasticizer,
filler,
    stabilizer, flame retardant, etc.) to satisfy
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((A2)+(B))/((A)+(B))=10-50 wt.%, and then kneading the mixture.
Title Terms: THERMOPLASTIC; ELASTOMER; COMPOSITION; MOULD; MATERIAL;
  PREPARATION; AUTOMOTIVE; DOMESTIC; APPLIANCE; PART; COMPRISE; BLOCK;
  POLYSTYRENE; BLOCK; COPOLYMER; POLYPHENYLENE; ETHER; RESIN
Derwent Class: A13; A17; A25
International Patent Class (Main): C08L-053/00
International Patent Class (Additional): C08L-071-12; C08L-053/00
File Segment: CPI
Manual Codes (CPI/A-N): A04-C01A; A04-G05; A05-H07A; A07-A04E; A11-B01
Polymer Indexing (PS):
  <01>
  *001* 018; R00966 G0055 G0044 G0033 G0022 D01 D02 D12 D10 D51 D53 D58
D84
        ; G0102-R G0022 D01 D12 D10 D18 D51 D53; R00708 G0102 G0022 D01
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        D12 D10 D19 D18 D31 D51 D53 D58 D76 D89; H0135 H0124; H0011-R;
        H0044-R H0011; K9449; P1150; P1741
  *002* 018; H0022 H0011; R00966 G0055 G0044 G0033 G0022 D01 D02 D12
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P1741
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P1741
  *005* 018; ND04; K9745-R; K9449; B9999 B3792 B3747; B9999 B5618
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  *008* 018; A999 A237
  *009* 018; A999 A486-R
  *010* 018; A999 A248-R
  *001* 018; D11 D10 D19 D18 D31 D76 D50 D88; P0997 P0964 H0293 F34 D01
D18
        ; K9449
  *002* 018; R00708 G0102 G0022 D01 D02 D12 D10 D19 D18 D31 D51 D53 D58
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D88; H0000; K9449; P1741; P1752